TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (L^2 - π -MOSV)

2SK2229

Chopper Regulator, DC-DC Converter and Motor Drive Applications

4-V gate drive

• Low drain-source ON resistance : $R_{DS (ON)} = 0.12 \Omega (typ.)$

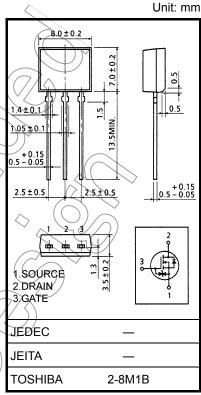
• High forward transfer admittance : $|Y_{fs}| = 5.0 \text{ S (typ.)}$

• Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 60 V)

• Enhancement mode : $V_{th} = 0.8$ to 2.0 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

				$/ \bigcirc / \wedge$
Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	60	À
Drain-gate voltage (Re	_{GS} = 20 kΩ)	V_{DGR}	60	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	ID	5	Α
	Pulse (Note 1)	I _{DP}	20	A
Drain power dissipatio	n	PD	1.3	<\w
Single pulse avalanche	e energy (Note 2)	EAS	129	mJ
Avalanche current		(TAR (5 <	\ A
Repetitive avalanche	energy (Note 3)	EAR	0.13	μή
Channel temperature	((√(ch	150	√°C
Storage temperature ra	ange	T _{stg}	-55 to 150	→°C



Weight: 0.54 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th (ch-a)}	96.1	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 7 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

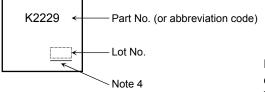
Electrical Characteristics (Ta = 25°C)

Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ	
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μA	
Drain-source br voltage	eakdown	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	60	_	_	V	
Gate threshold v	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	(0.8)	4	2.0	V	
D : 011 : 1	N recistance	Pro (ou)	V _{GS} = 4 V, I _D = 1.3 A		0.20	0.30	Ω	
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 2.5 A	/	0.12	0.16	Ω	
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	3.0	5.0	_	S	
Input capacitano	e	C _{iss}		_	370	_		
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	1	60	_	pF	
Output capacitance		Coss	4(>>	1	180	\rightarrow		
Switching time	Rise time	t _r	VGS OV TOUT		18	> -		
	Turn-on time	t _{on}	R _L =		25) _	ns	
	Fall time	t _f			~ 55	_	115	
	Turn-off time	t _{off}	$V_{DD} = 30V$ Duty \(\leq 1\%, \text{t}_{\text{W}} = 10\mu\text{s}) –	170	_		
Total gate charg plus gate-drain)		Qg		_	12	_		
Gate-source charge		Qgs	$V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	_	8	_	nC	
Gate-drain ("miller") charge		Qgd		-	4	_		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	IDR = 5 A, VGS = 0 V, dIDR/dt = 50 A/µs	_	70	_	ns
Reverse recovered charge	Qrr	IDK - 5 A, VGS - 6 V, dipk/dt - 30 A/µs	_	0.1	_	μC

Marking

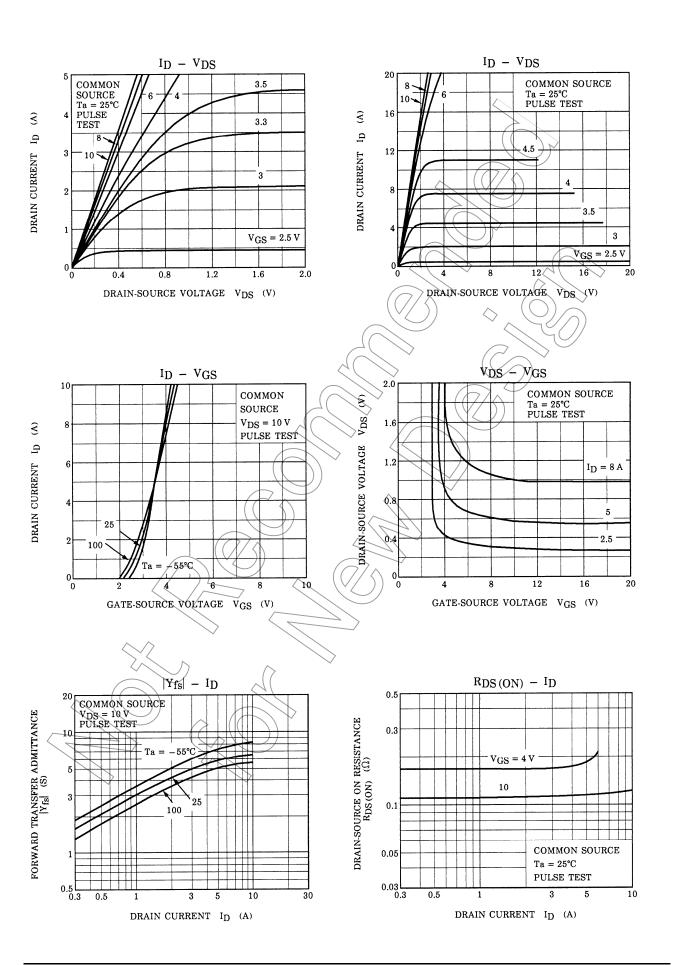


Note 4: A line under a Lot No. identifies the indication of product Labels.

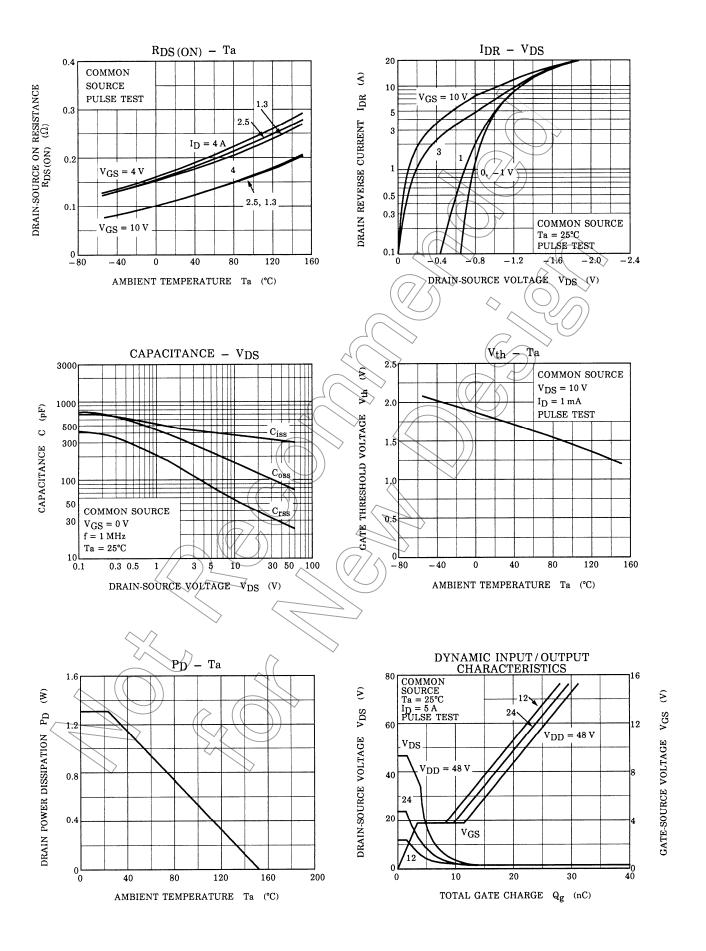
Not underlined: [[Pb]]/INCLUDES > MCV

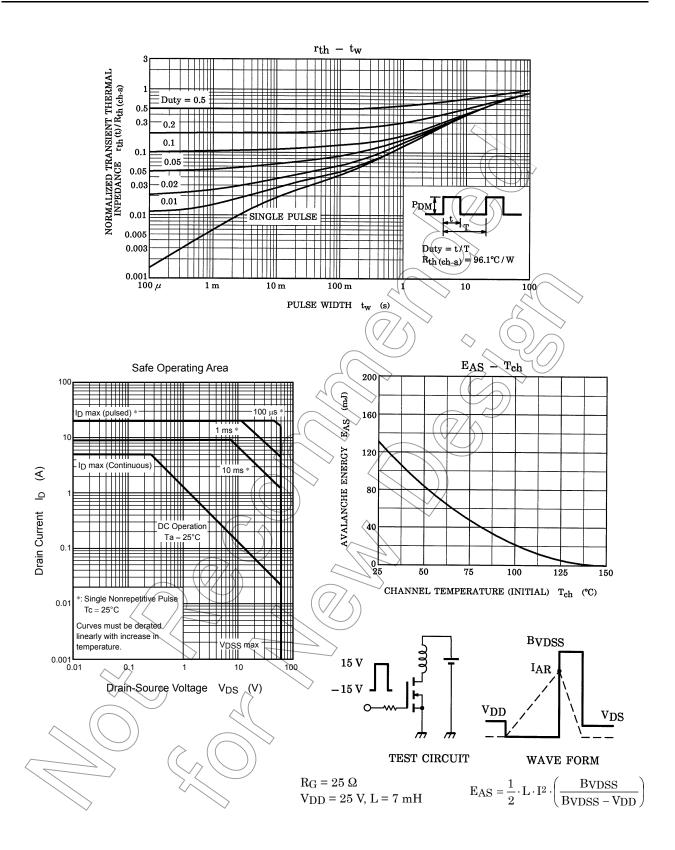
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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